LP2951JAN Series of Adjustable Micropower Voltage Regulators

Check for Samples: LP2951JAN

FEATURES

- **High accuracy output voltage**
- **Guaranteed 100mA output current**
- **Extremely low quiescent current**
- **Low dropout voltage**
- **Extremely tight load and line regulation**
- **Very low temperature coefficient**
- **Use as Regulator or Reference**
- **Needs minimum capacitance for stability**
- **Current and Thermal Limiting**
- **Stable with low-ESR output capacitors (10mΩ to 6Ω)**
- **Error flag warns of output dropout**
- **Logic-controlled electronic shutdown**
- **Output programmable from 1.24 to 29V**

DESCRIPTION

The LP2951 is a micropower voltage regulator with very low quiescent current (75µA typ.) and very low dropout voltage (typ. 40mV at light loads and 380mV at 100mA). It is ideally suited for use in battery-powered systems. Furthermore, the quiescent current increases only slightly in dropout, prolonging battery life.

An additional feature is an error flag output which warns of a low output voltage, often due to falling batteries on the input. It may be used for a power-on reset. A second feature is the logic-compatible shutdown input which enables the regulator to be switched on and off. Also, the part may be pin-strapped for a 5V, 3V, or 3.3V output (depending on the version), or programmed from 1.24V to 29V with an external pair of resistors.

Careful design of the LP2951 has minimized all contributions to the error budget. This includes a tight initial tolerance (0.5% typ.), extremely good load and line regulation (0.05% typ.) and a very low output voltage temperature coefficient, making the part useful as a low-power voltage reference.

Connection Diagrams

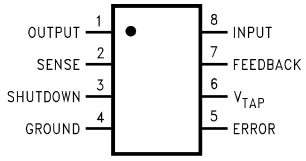

Figure 1. Dual-In-Line Packages (J)
Top View

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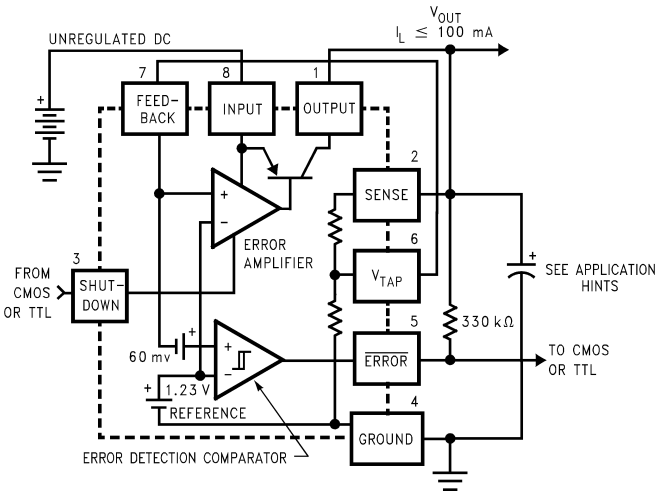
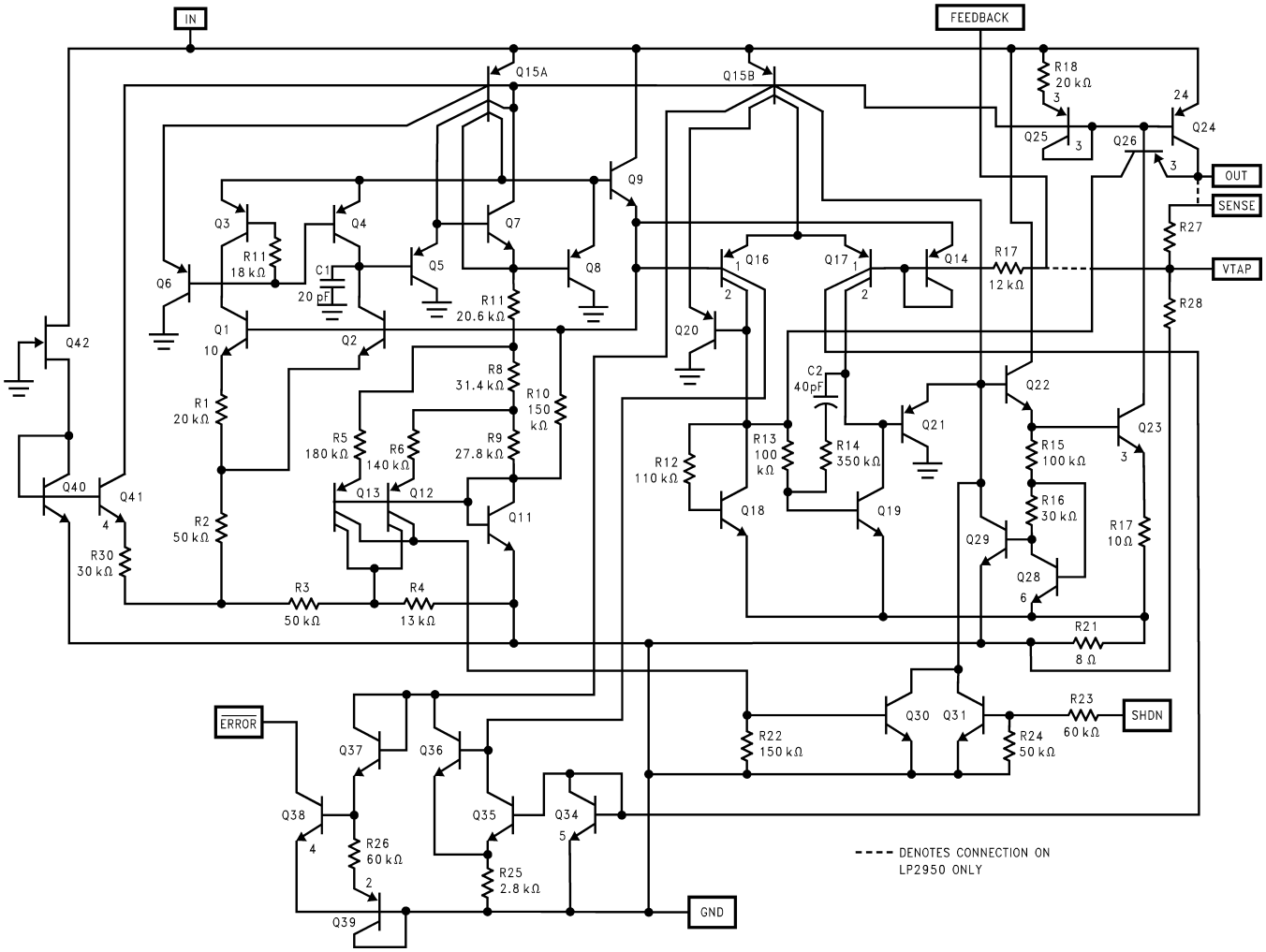
Block Diagram



Schematic Diagram



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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings (1)

Input Supply Voltage			−0.3 to +30V
Shutdown Input Voltage (2)			−0.3 to +30V
Error Comparator Output Voltage (2)			−0.3 to +30V
Feedback Input Voltage (2), (3)			−1.5 to +30V
Power Dissipation (4) Ceramic DIP			1.0 W @ 25°C
Junction Temperature (T_J)			+160°C
Ambient Storage Temperature Range			−65°C ≤ T_A ≤ +150°C
Ambient Operating Temperature Range			−55°C ≤ T_A ≤ +125°C
Lead Temperature (Soldering 10 Seconds)			260°C
Thermal Resistance	θ_{JA}	Ceramic DIP (Still Air @ 0.5W)	131°C/W
		Ceramic DIP (500LF/Min Air flow @ 0.5W)	75°C/W
	θ_{JC}	Ceramic DIP	21°C/W
ESD Rating (5)			500V

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
(2) May exceed input supply voltage.
(3) When used in dual-supply systems where the output terminal sees loads returned to a negative supply, the output voltage should be diode-clamped to ground.
(4) The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{Jmax} (maximum junction temperature), θ_{JA} (package junction to ambient thermal resistance), and T_A (ambient temperature). The maximum allowable power dissipation at any temperature is $P_{Dmax} = (T_{Jmax} - T_A)/\theta_{JA}$ or the number given in the Absolute Maximum Ratings, whichever is lower.
(5) Human body model, 1.5 kΩ in series with 100 pF.

Quality Conformance Inspection

Table 1. Mil-Std-883, Method 5005 - Group A

SUBGROUP	DESCRIPTION	TEMP (°C)
1	Static tests at	+25
2	Static tests at	+125
3	Static tests at	–55
4	Dynamic tests at	+25
5	Dynamic tests at	+125
6	Dynamic tests at	–55
7	Functional tests at	+25
8A	Functional tests at	+125
8B	Functional tests at	–55
9	Switching tests at	+25
10	Switching tests at	+125
11	Switching tests at	–55
12	Settling time at	+25
13	Settling time at	+125
14	Settling time at	–55

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JL2951 Electrical Characteristics DC Parameters

The following conditions apply, unless otherwise specified. V_{IN} = 6V, I_L = −100µA, C_L = 3.3µF, V_O = 5V (Nominal), V_{SD} = 0.6V

SYMBOL	PARAMETER	CONDITIONS	NOTES	MIN	MAX	UNIT	SUBGROUPS
V_O	Output Voltage			4.975	5.025	V	1
				4.94	5.06	V	2, 3
$V_{O\ Line}$	Line Regulation	6V ≤ V_{IN} ≤ 30V, I_L = –1mA		–5.0	5.0	mV	1
				–25	25	mV	2, 3
$V_{O\ Load}$	Load Regulation	–100µA ≤ I_L ≤ –100mA,		–5.0	5.0	mV	1
				–25	25	mV	2, 3
V_D	Dropout Voltage	I_L = –100mA			450	mV	1
					600	mV	2, 3
					80	mV	1
					150	mV	2, 3
I_G	Ground Current	I_L = –100mA,			12	mA	1
					14	mA	2, 3
					120	µA	1
					140	µA	2, 3
		V_O = 15V, V_{IN} = 30V			120	µA	1
					140	µA	2, 3
		V_{IN} = 30V, V_O = 15V			15	mA	1
					20	mA	2, 3
$I_{G\ Diff}$	Ground Current Change	6V ≤ V_{IN} ≤ 30V		–30	30	µA	1
				–50	50	µA	2, 3
I_{GDO}	Dropout Ground Current	V_{IN} = 4.5V			170	µA	1
					200	µA	2, 3
$V_{Th\ L}$	Error Comparator Lower Threshold Voltage			0.0	0.8	mV	1, 2, 3
$V_{Th\ U}$	Error Comparator Upper Threshold Voltage			2.0	30	mV	1, 2, 3
θ_R	Thermal Regulation	V_{IN} = 30V, I_L = –50mA, 2ms ≤ T ≤ 10ms		–12.5	12.5	mV	1
I_{SC}	Current Limit	V_O = 0V,			200	mA	1
					220	mA	2, 3
I_{GSC}	Ground Current At Current Limit	V_O = 0V,			20	mA	1
					25	mA	2, 3
V_{Ref}	Reference Voltage			1.22	1.25	V	1
				1.20	1.26	V	2, 3
$V_{R\ Line}$	Reference Voltage Line Regulation	2.3V ≤ V_{IN} ≤ 30V		–1.9	1.9	mV	1
				–10	10	mV	2, 3
$V_{R\ Load}$	Reference Voltage Output Regulation	1.2V ≤ V_O ≤ 29V, V_{IN} = 30V		–1.2	1.2	mV	1
				–5.0	5.0	mV	2, 3
I_{FB}	Feedback Pin Bias Current				40	nA	1
					60	nA	2, 3
I_{OH}	Error Comparator Output Leakage Current	V_O = 30V			1.0	µA	1
					2.0	µA	2, 3
V_{OL}	Error Comparator Output Low Voltage	V_{IN} = 4.5V, V_{SD} = 2V			250	mV	1
					400	mV	2, 3

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JL2951 Electrical Characteristics DC Parameters (continued)

The following conditions apply, unless otherwise specified. V_{IN} = 6V, I_L = −100µA, C_L = 3.3µF, V_O = 5V (Nominal), V_{SD} = 0.6V

SYMBOL	PARAMETER	CONDITIONS	NOTES	MIN	MAX	UNIT	SUBGROUPS
I_{SD}	Shutdown Pin Input Current	V_{SD} = 2.4V			50	µA	1
					100	µA	2, 3
		V_{SD} = 30V			600	µA	1
					750	µA	2, 3
V_{SDL}	Shutdown Input Logic Voltage	Low	(1)		0.6	V	1, 2, 3
V_{SDH}	Shutdown Input Logic Voltage	High	(1)	2.0		V	1, 2, 3
I_{LKG}	Regular Output Bias Current In Shutdown	V_{SD} = 2V, V_{IN} = 30V, I_L = 0mA		–10	10	µA	1
				–20	20	µA	2, 3

(1) Parameter tested go-no-go only.

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JL2951 Electrical Characteristics AC Parameters

The following conditions apply, unless otherwise specified. V_{IN} = 6V, C_L = 3.3µF, V_{SD} = 0.6V

SYMBOL	PARAMETER	CONDITIONS	NOTES	MIN	MAX	UNIT	SUBGROUP
RR	Ripple Rejection	f = 120Hz, V_{IN} = 0.1V_{RMS}		50		dB	4
V_{Noise}	Output Noise	C_L = 1µF			600	µV_{RMS}	7
		C_L = 3.3µF			250	µV_{RMS}	7

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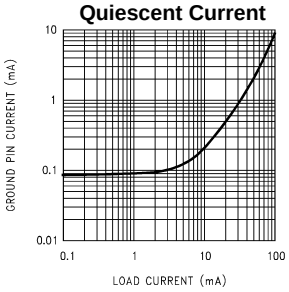
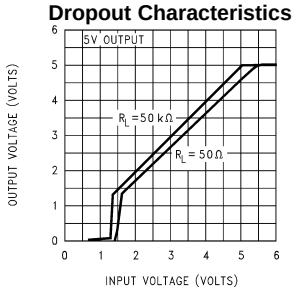
Typical Performance Characteristics

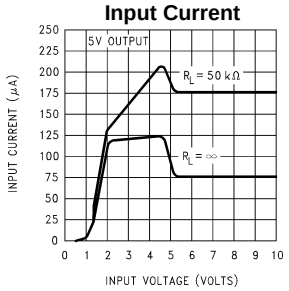
Quiescent Current



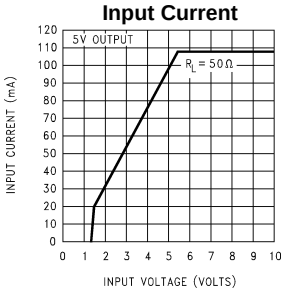
Dropout Characteristics



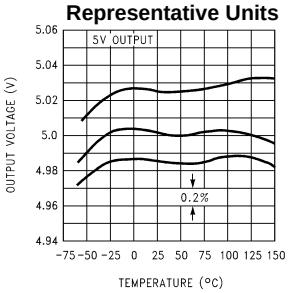
Input Current



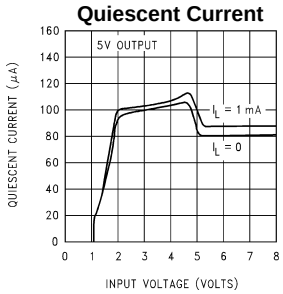
Input Current



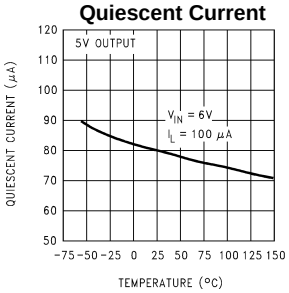
Output Voltage vs. Temperature of 3 Representative Units



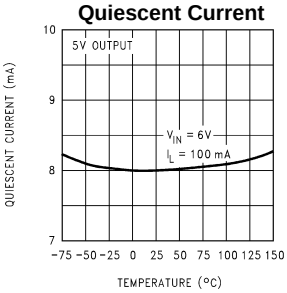
Quiescent Current



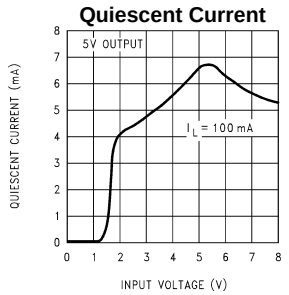
Quiescent Current



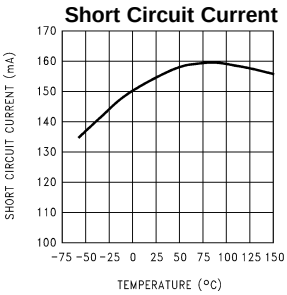
Quiescent Current



Quiescent Current

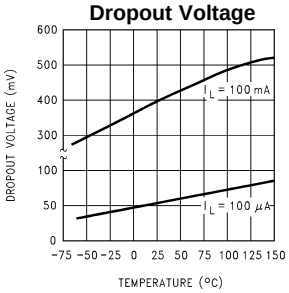


Short Circuit Current

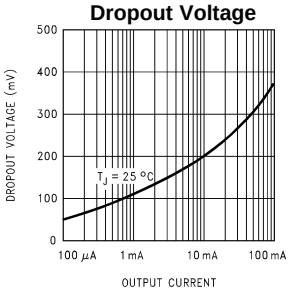


Typical Performance Characteristics (continued)

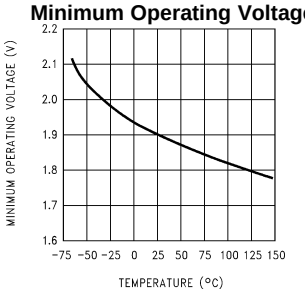
Dropout Voltage



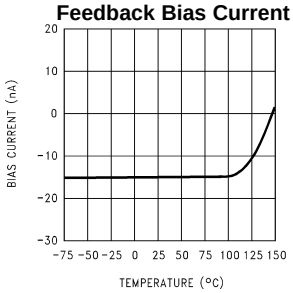
Dropout Voltage



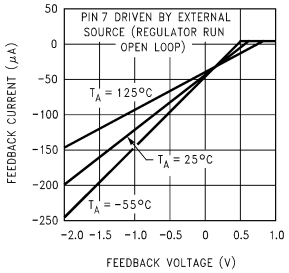
Minimum Operating Voltage



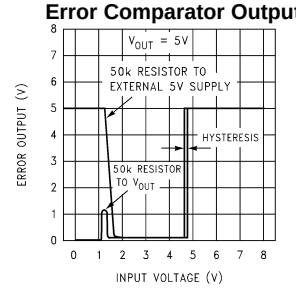
Feedback Bias Current



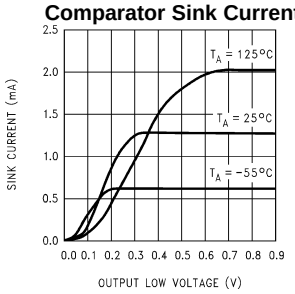
Feedback Pin Current



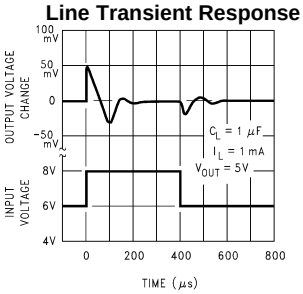
Error Comparator Output



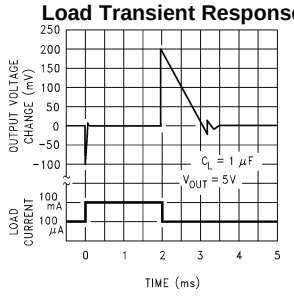
Comparator Sink Current



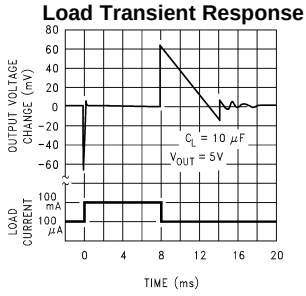
Line Transient Response



Load Transient Response



Load Transient Response



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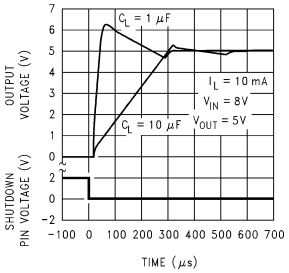
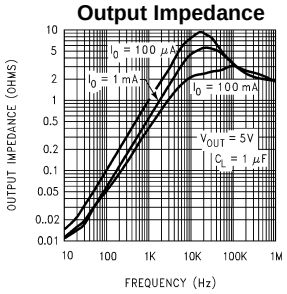
Typical Performance Characteristics (continued)

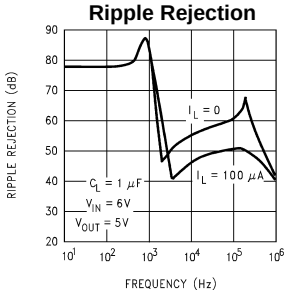
Enable Transient



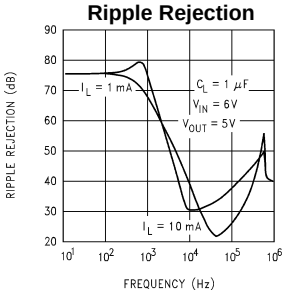
Output Impedance



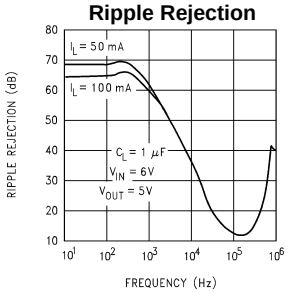
Ripple Rejection



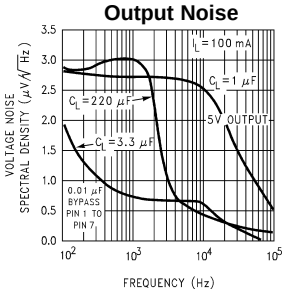
Ripple Rejection



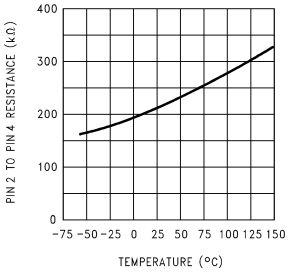
Ripple Rejection



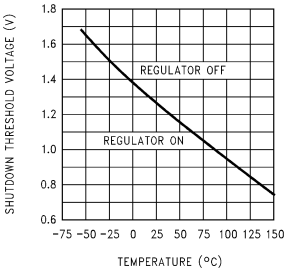
Output Noise



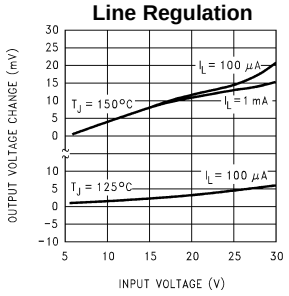
Divider Resistance



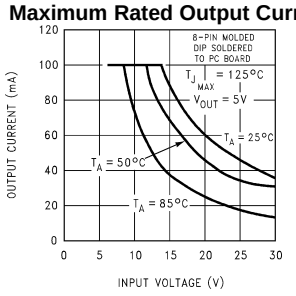
Shutdown Threshold Voltage



Line Regulation



Maximum Rated Output Current



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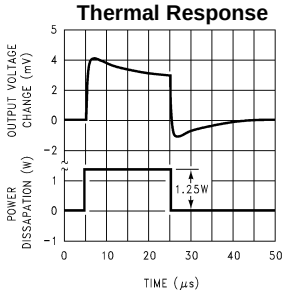
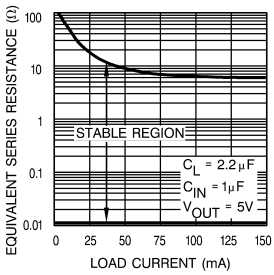
Typical Performance Characteristics (continued)

Thermal Response



Output Capacitor ESR Range



Application Hints

External Capacitors

A 1.0μF (or greater) capacitor is required between the output and ground for stability at output voltages of 5V or more. At lower output voltages, more capacitance is required (2.2μF or more is recommended for 3V and 3.3V versions). Without this capacitor the part will oscillate. Most types of tantalum or aluminum electrolytics work fine here; even film types work but are not recommended for reasons of cost. Many aluminum electrolytics have electrolytes that freeze at about −30°C, so solid tantalums are recommended for operation below −25°C. The important parameters of the capacitor are an ESR of about 5Ω or less and a resonant frequency above 500kHz. The value of this capacitor may be increased without limit.

Ceramic capacitors whose value is greater than 1000pF should not be connected directly from the LP2951 output to ground. Ceramic capacitors typically have ESR values in the range of 5 to 10mΩ, a value below the lower limit for stable operation (see curve Output Capacitor ESR Range).

The reason for the lower ESR limit is that the loop compensation of the part relies on the ESR of the output capacitor to provide the zero that gives added phase lead. The ESR of ceramic capacitors is so low that this phase lead does not occur, significantly reducing phase margin. A ceramic output capacitor can be used if a series resistance is added (recommended value of resistance is about 0.1Ω to 2Ω).

At lower values of output current, less output capacitance is required for stability. The capacitor can be reduced to 0.33μF for currents below 10mA or 0.1μF for currents below 1mA. Using the adjustable versions at voltages below 5V runs the error amplifier at lower gains so that *more* output capacitance is needed. For the worst-case situation of a 100mA load at 1.23V output (Output shorted to Feedback) a 3.3μF (or greater) capacitor should be used.

When setting the output voltage of the LP2951 with external resistors, a minimum load of 1μA is recommended.

A 1μF tantalum, ceramic or aluminum electrolytic capacitor should be placed from the LP2951 input to ground if there is more than 10 inches of wire between the input and the AC filter capacitor or if a battery is used as the input.

Stray capacitance to the LP2951 Feedback terminal can cause instability. This may especially be a problem when using high value external resistors to set the output voltage. Adding a 100pF capacitor between Output and Feedback and increasing the output capacitor to at least 3.3μF will fix this problem.

Error Detection Comparator Output

The comparator produces a logic low output whenever the LP2951 output falls out of regulation by more than approximately 5%. This figure is the comparator's built-in offset of about 60mV divided by the 1.235 reference voltage. (Refer to the Block Diagram in the front of the datasheet.) This trip level remains 5% below normal regardless of the programmed output voltage of the 2951. For example, the error flag trip level is typically 4.75V for a 5V output or 11.4V for a 12V output. The out of regulation condition may be due either to low input voltage, current limiting, or thermal limiting.

Figure 2 below gives a timing diagram depicting the $\overline{\text{ERROR}}$ signal and the regulated output voltage as the LP2951 input is ramped up and down. For 5V versions, the $\overline{\text{ERROR}}$ signal becomes valid (low) at about 1.3V input. It goes high at about 5V input (the input voltage at which V_{OUT} = 4.75V). Because the LP2951's dropout voltage is load-dependent (see curve Dropout Voltage), the **input** voltage trip point (about 5V) will vary with the load current. The **output** voltage trip point (approx. 4.75V) does not vary with load.

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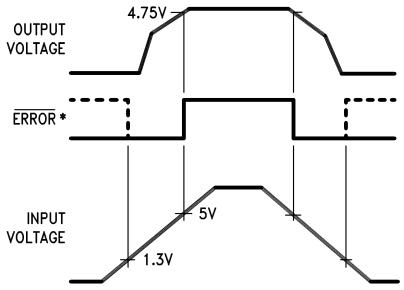
The error comparator has an open-collector output which requires an external pullup resistor. This resistor may be returned to the output or some other supply voltage depending on system requirements. In determining a value for this resistor, note that while the output is rated to sink 400µA, this sink current adds to battery drain in a low battery condition. Suggested values range from 100kΩ to 1 MΩ. The resistor is not required if this output is unused.



*When $V_{IN} \leq 1.3V$, the error flag pin becomes a high impedance, and the error flag voltage rises to its pull-up voltage. Using V_{OUT} as the pull-up voltage (see Figure 3), rather than an external 5V source, will keep the error flag voltage under 1.2V (typ.) in this condition. The user may wish to divide down the error flag voltage using equal-value resistors (10kΩ suggested), to ensure a low-level logic signal during any fault condition, while still allowing a valid high logic level during normal operation.

Figure 2. $\overline{\text{ERROR}}$ Output Timing

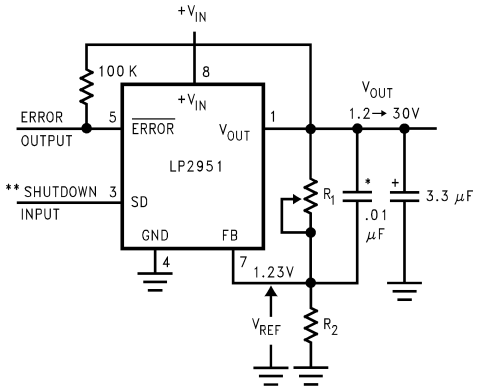
Programming The Output Voltage (LP2951)

The LP2951 may be pin-strapped for the nominal fixed output voltage using its internal voltage divider by tying the output and sense pins together, and also tying the feedback and V_{TAP} pins together. Alternatively, it may be programmed for any output voltage between its 1.235V reference and its 30V maximum rating. As seen in Figure 3, an external pair of resistors is required.

The complete equation for the output voltage is

$$V_{OUT} = V_{REF} \bullet \left(1 + \frac{R_1}{R_2}\right) + I_{FB}R_1 \quad (1)$$

where V_{REF} is the nominal 1.235 reference voltage and I_{FB} is the feedback pin bias current, nominally −20nA. The minimum recommended load current of 1µA forces an upper limit of 1.2 MΩ on the value of R_2, if the regulator must work with no load (a condition often found in CMOS in standby). I_{FB} will produce a 2% typical error in V_{OUT} which may be eliminated at room temperature by trimming R_1. For better accuracy, choosing R_2 = 100kΩ reduces this error to 0.17% while increasing the resistor program current to 12µA. Since the LP2951 typically draws 60µA at no load with Pin 2 open-circuited, this is a small price to pay.



*See Application Hints

$V_{out} = V_{Ref}\left(1 + \frac{R_1}{R_2}\right)$

**Drive with TTL-high to shut down. Ground or leave open if shutdown feature is not to be used.

Note: Pins 2 and 6 are left open.

Figure 3. Adjustable Regulator

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Reducing Output Noise

In reference applications it may be advantageous to reduce the AC noise present at the output. One method is to reduce the regulator bandwidth by increasing the size of the output capacitor.

Noise can be reduced fourfold by a bypass capacitor across R_1, since it reduces the high frequency gain from 4 to unity. Pick

$$C_{BYPASS} \cong \frac{1}{2\pi R_1 \bullet 200\ Hz} \quad (2)$$

or about 0.01µF. When doing this, the output capacitor must be increased to 3.3µF to maintain stability. These changes reduce the output noise from 430µV to 100µV rms for a 100kHz bandwidth at 5V output. With the bypass capacitor added, noise no longer scales with output voltage so that improvements are more dramatic at higher output voltages.

Typical Applications

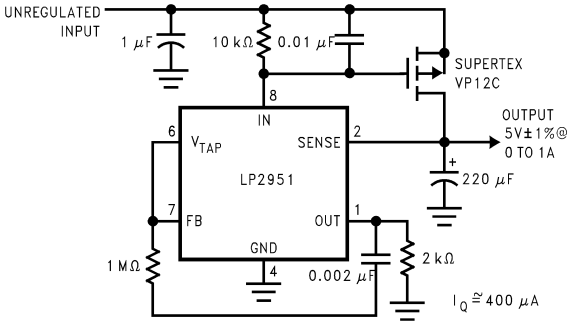


Figure 4. 1A Regulator with 1.2V Dropout

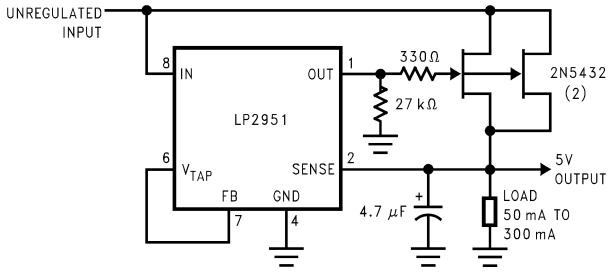
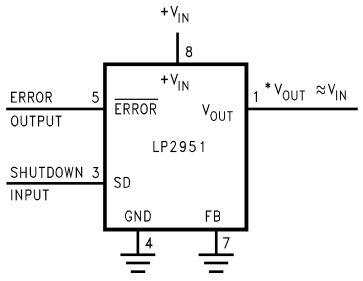


Figure 5. 300mA Regulator with 0.75V Dropout



*Minimum input-output voltage ranges from 40mV to 400mV, depending on load current. Current limit is typically 160mA.

Figure 6. Wide Input Voltage Range Current Limiter

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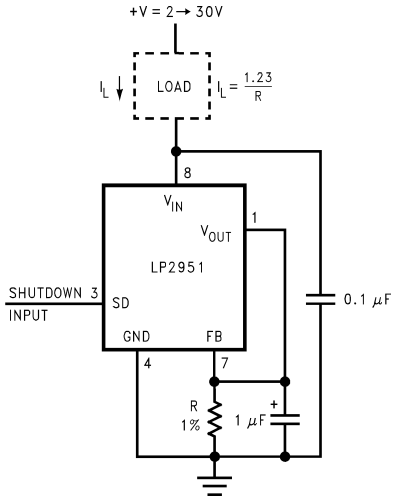
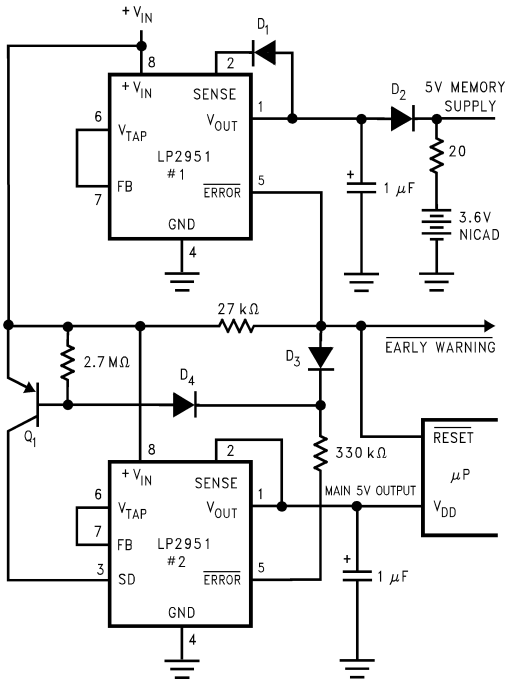


Figure 7. Low Drift Current Source



- Early warning flag on low input voltage
- Main output latches off at lower input voltages
- Battery backup on auxiliary output
- Operation: Reg. #1's V_{out} is programmed one diode drop above 5V. Its error flag becomes active when $V_{in} \leq 5.7V$. When V_{in} drops below 5.3V, the error flag of Reg. #2 becomes active and via Q1 latches the main output off. When V_{in} again exceeds 5.7V Reg. #1 is back in regulation and the early warning signal rises, unlatching Reg. #2 via D3.

Figure 8. Regulator with Early Warning and Auxiliary Output

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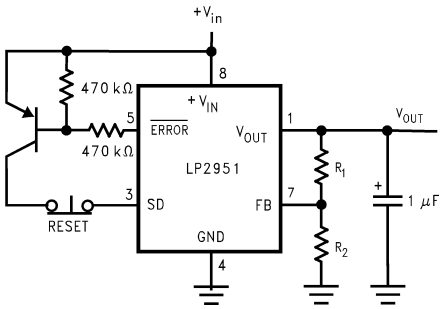
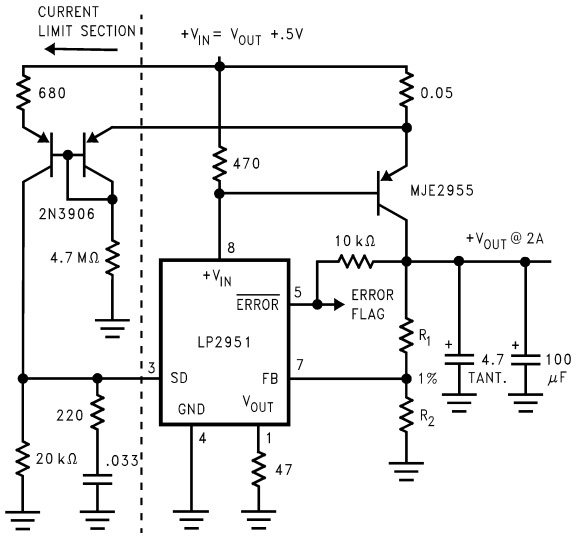


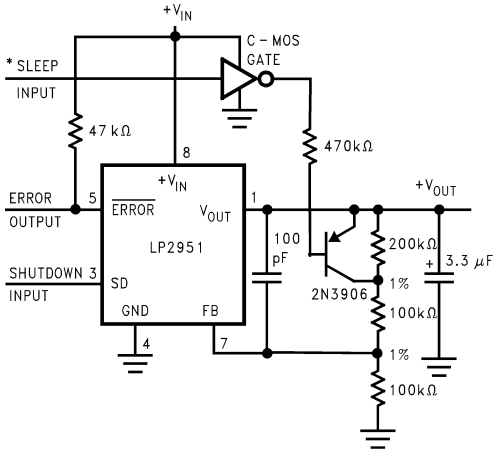
Figure 9. Latch Off When Error Flag Occurs



$$V_{out} = 1.23V \left(1 + \frac{R_1}{R_2}\right)$$

For $5V_{out}$, use internal resistors. Wire pin 6 to 7, & wire pin 2 to $+V_{out}$ Bus.

Figure 10. 2 Ampere Low Dropout Regulator



*High input lowers V_{out} to 2.5V

Figure 11. 5V Regulator with 2.5V Sleep Function

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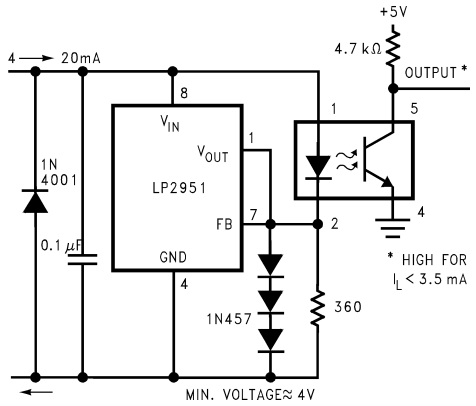
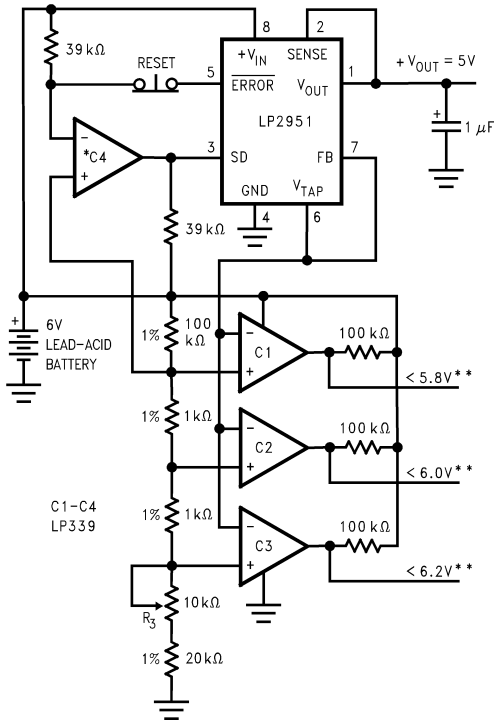
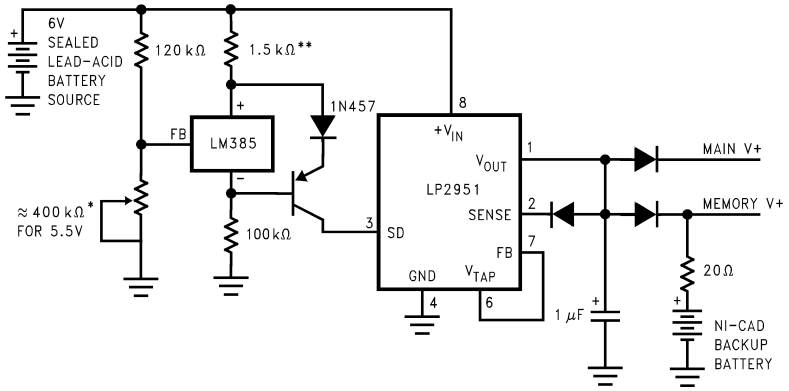


Figure 12. Open Circuit Detector for 4 to 20mA Current Loop



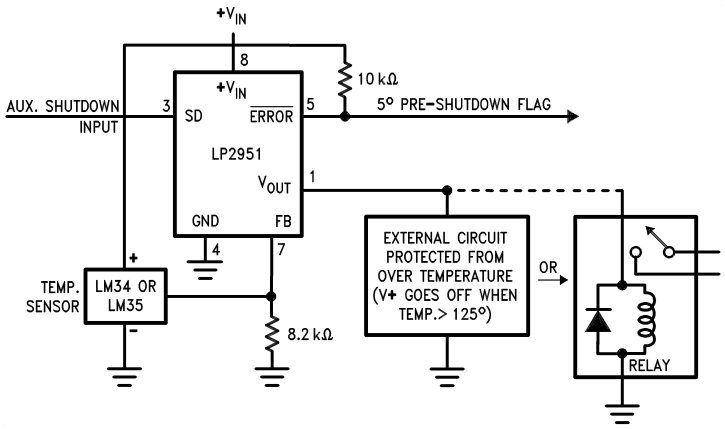
*Optional Latch off when drop out occurs. Adjust R3 for C2 Switching when V_{in} is 6.0V.
**Outputs go low when V_{in} drops below designated thresholds.

Figure 13. Regulator with State-of-Charge Indicator



For values shown, Regulator shuts down when V_{in} < 5.5V and turns on again at 6.0V. Current drain in disconnected mode is ≈ 150µA.
*Sets disconnect Voltage
**Sets disconnect Hysteresis

Figure 14. Low Battery Disconnect



LM34 for 125°F Shutdown
LM35 for 125°C Shutdown

Figure 15. System Overtemperature Protection Circuit

Table 2. Revision History

Released	Revision	Section	Changes
11/30/2010	A	New Release, Corporate format	1 MDS data sheet converted into one Corp. data sheet format. MJLP2951-X Rev 1B1 will be archived.

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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Samples (Requires Login)
5962-3870501BPA	ACTIVE	CDIP	NAB	8	40	TBD	A42 SNPB	Level-1-NA-UNLIM	
JL2951BPA	ACTIVE	CDIP	NAB	8	40	TBD	A42 SNPB	Level-1-NA-UNLIM	

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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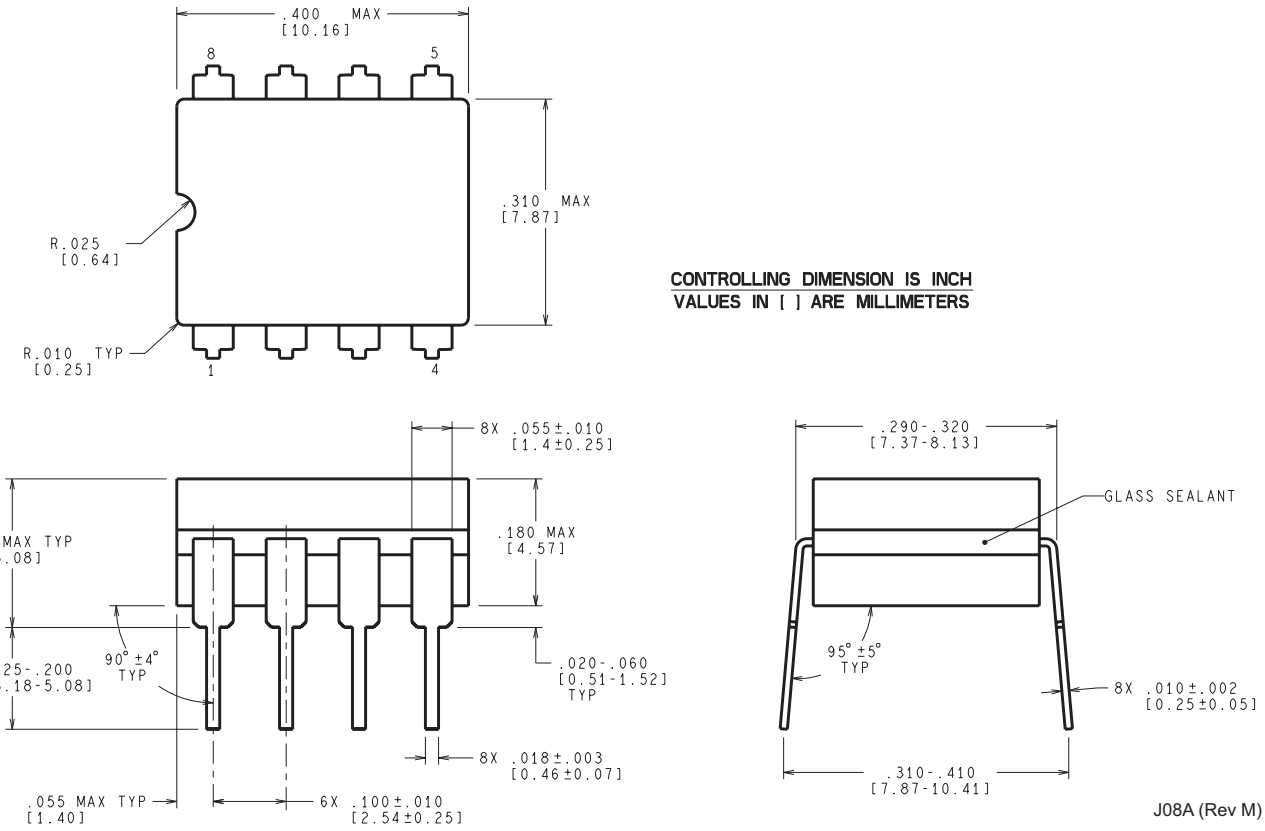
OTHER QUALIFIED VERSIONS OF LP2951JAN, LP2951JAN-SP :

- Military: LP2951JAN
- Space: LP2951JAN-SP

NOTE: Qualified Version Definitions:

- Military - QML certified for Military and Defense Applications
- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

NAB0008A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TYP
8X .010±.002
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